

N-Channel 200 V (D-S) MOSFET

PRODUCT SUMMARY

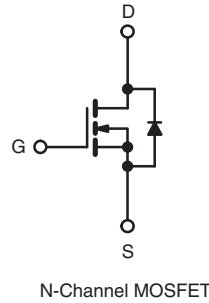
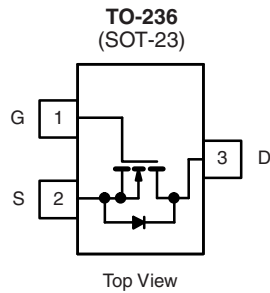
| | | |
|--------------|---------------------------|-----------|
| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) |
| 200 | 1.4 at $V_{GS} = 10$ V | 0.6 |

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % R_g and UIS Tested
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE
Available



ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)

| Parameter | Symbol | 5 s | Steady State | Unit |
|---|----------------|---------------|--------------|------|
| Drain-Source Voltage | V_{DS} | 200 | | V |
| Gate-Source Voltage | V_{GS} | ± 20 | | |
| Continuous Drain Current ($T_J = 150$ °C) ^a | I_D | $T_A = 25$ °C | 0.6 | A |
| | | $T_A = 70$ °C | 0.5 | |
| Pulsed Drain Current ^b | I_{DM} | 2.5 | | mJ |
| Avalanche Current ^b | I_{AS} | 2.5 | | |
| Single Avalanche Energy | E_{AS} | 50 | | A |
| Continuous Source Current (Diode Conduction) ^a | I_S | 0.6 | | |
| Power Dissipation ^a | P_D | $T_A = 25$ °C | 1.55 | W |
| | | $T_A = 70$ °C | 1.20 | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to 150 | | °C |

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Typical | Maximum | Unit |
|--|------------|--------------|---------|------|
| Maximum Junction-to-Ambient ^a | R_{thJA} | $t \leq 5$ s | 80 | °C/W |
| | | Steady State | 130 | |
| Maximum Junction-to-Foot | R_{thJF} | 45 | 55 | |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. Pulse width limited by maximum junction temperature.

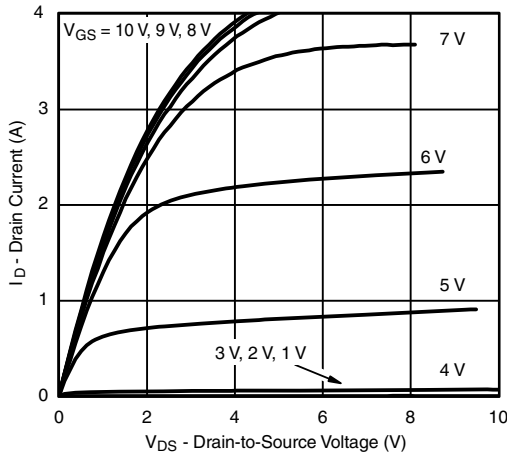
| SPECIFICATIONS (T _A = 25 °C, unless otherwise noted) | | | | | | |
|---|---------------------|---|--------|------|-------|------|
| Parameter | Symbol | Test Conditions | Limits | | | Unit |
| | | | Min. | Typ. | Max. | |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 1 mA | 200 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1.5 | | 3.5 | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | μA |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 70 °C | | | 75 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≥ 15 V, V _{GS} = 10 V | 2.5 | | | A |
| Drain-Source On-Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 0.5 A | | 1.4 | | Ω |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 0.5 A | | 4 | | S |
| Diode Forward Voltage | V _{SD} | I _S = 1 A, V _{GS} = 0 V | | 0.8 | 1.2 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q _g | V _{DS} = 100 V, V _{GS} = 10 V, I _D = 0.5 A | | 3 | 5 | nC |
| Gate-Source Charge | Q _{gs} | | | 0.37 | | |
| Gate-Drain Charge | Q _{gd} | | | 1.45 | | |
| Gate Resistance | R _g | | 0.5 | 1.3 | 2.4 | Ω |
| Switching | | | | | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 100 V, R _L = 33 Ω I _D ≅ 0.2 A, V _{GEN} = 10 V, R _g = 6 Ω | | 7 | 11 | ns |
| Rise Time | t _r | | | 10 | 15 | |
| Turn-Off Delay Time | t _{d(off)} | | | 9 | 15 | |
| Fall Time | t _f | | | 11 | 15 | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 0.5 A, di/dt = 100 A/μs50100 | | | | |

Notes:

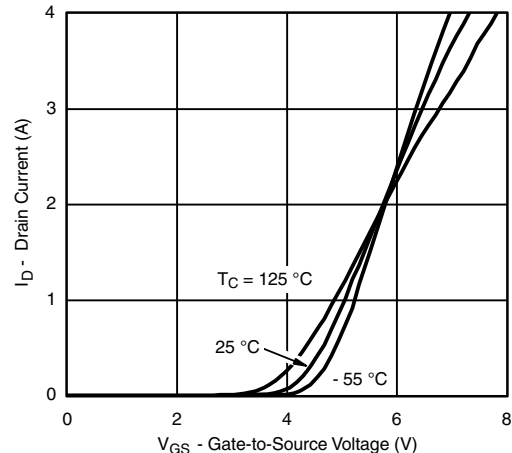
- a. Pulse test: PW ≤ 300 μs, duty cycle ≤ 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

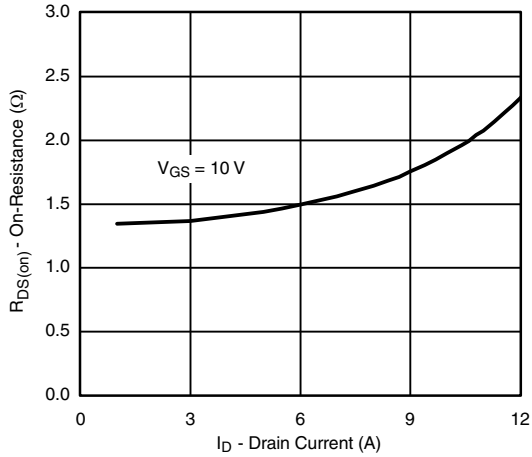


Output Characteristics

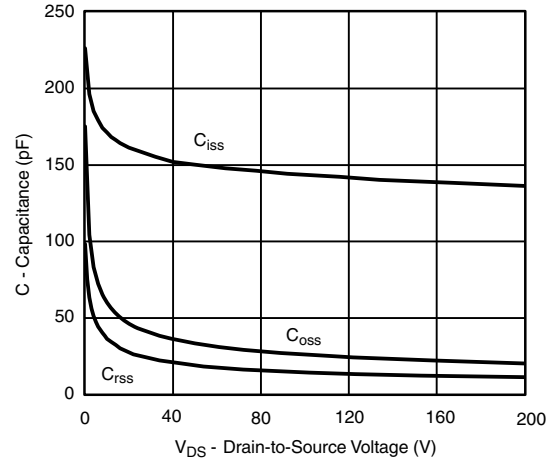


Transfer Characteristics

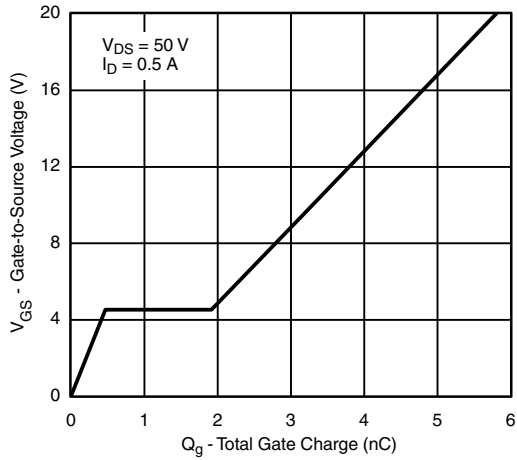
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



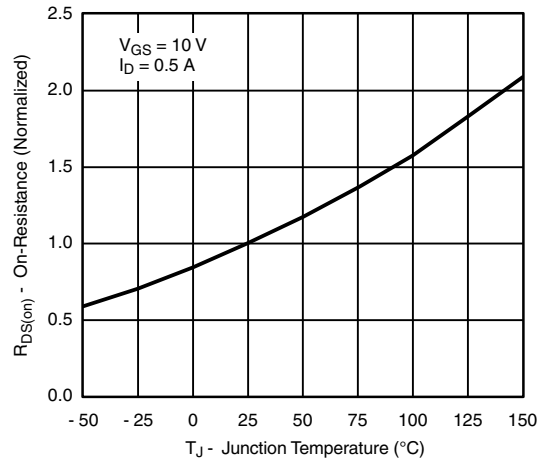
On-Resistance vs. Drain Current



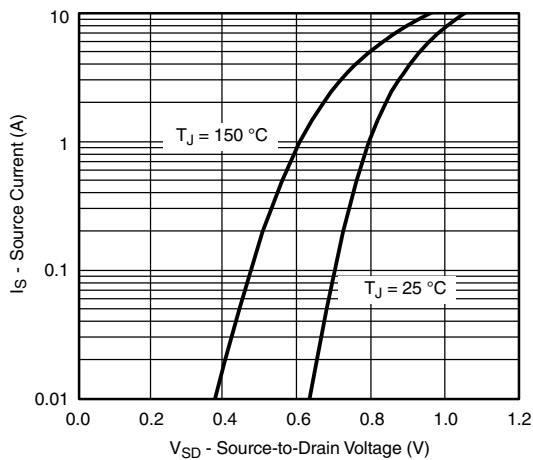
Capacitance



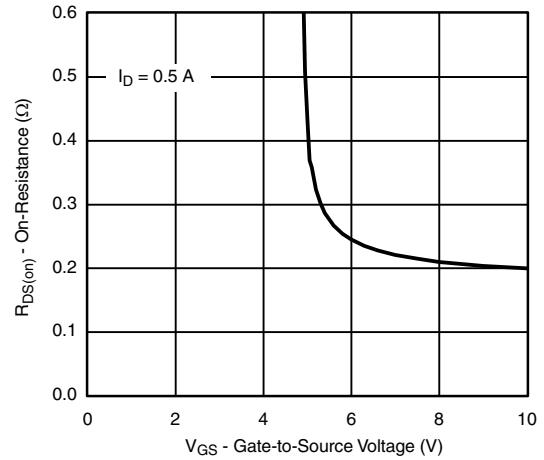
Gate Charge



On-Resistance vs. Junction Temperature

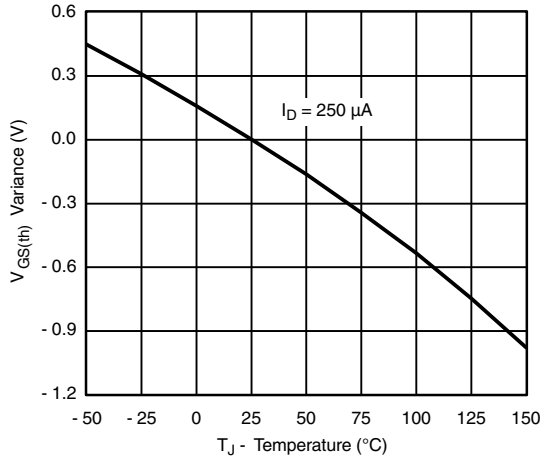


Source-Drain Diode Forward Voltage

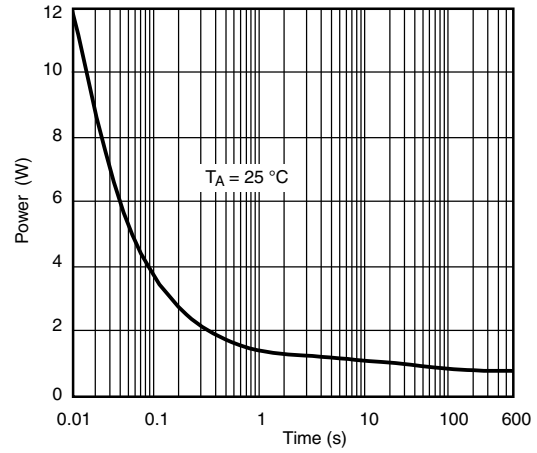


On-Resistance vs. Gate-to-Source Voltage

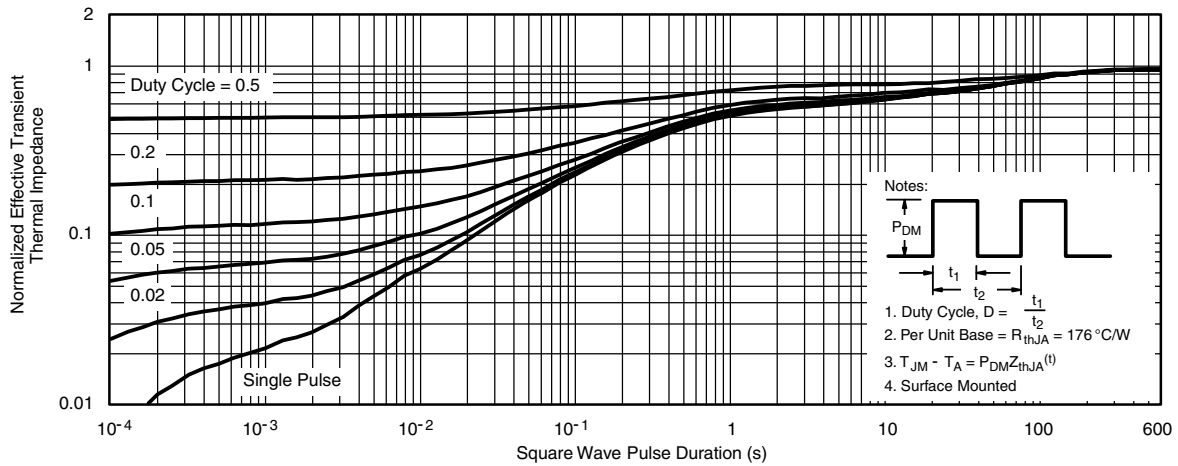
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Threshold Voltage

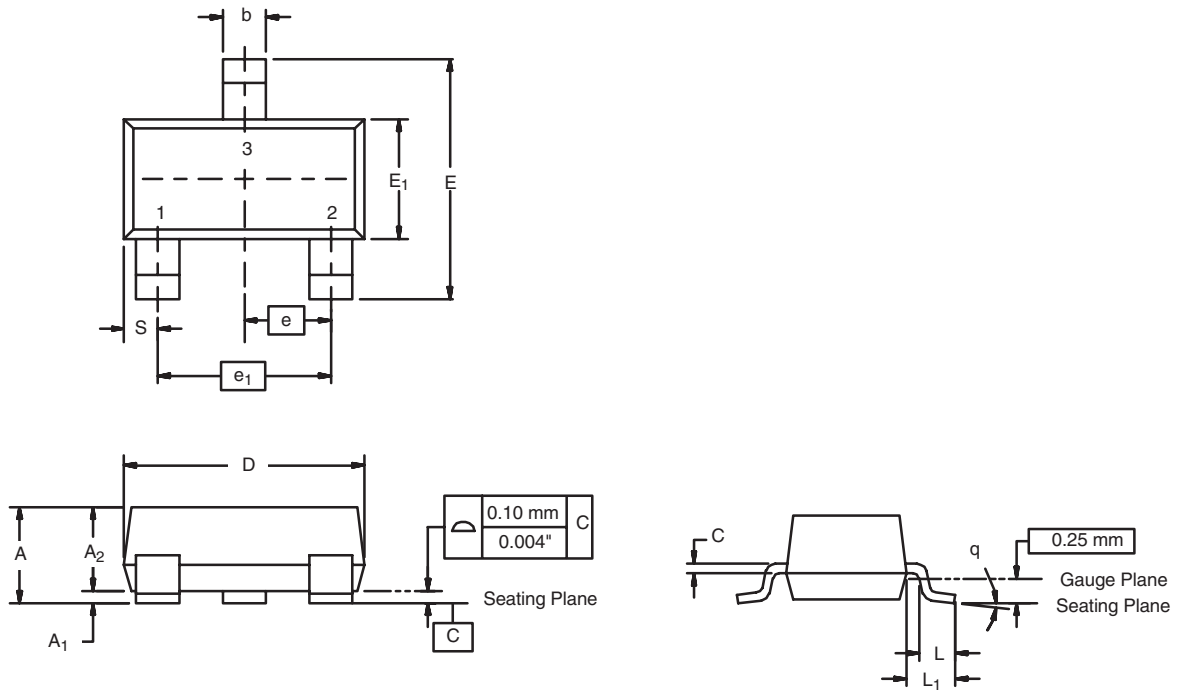


Single Pulse Power



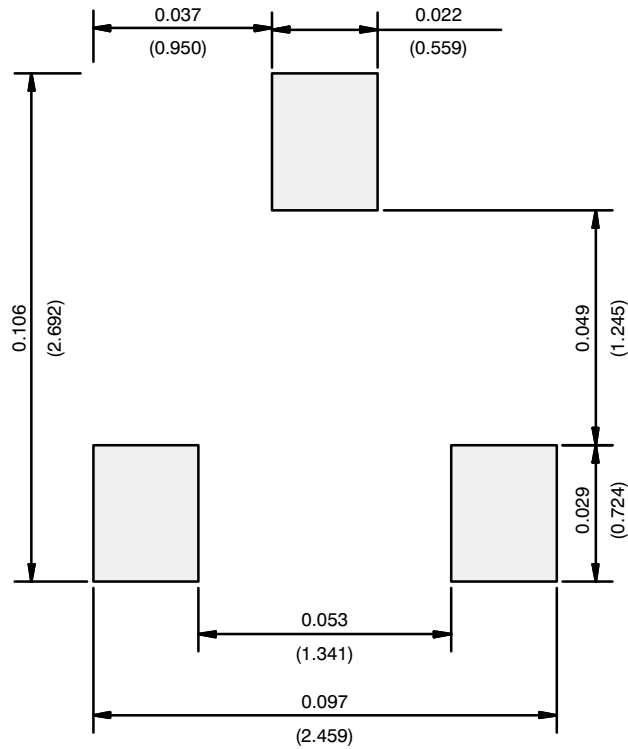
Normalized Thermal Transient Impedance, Junction-to-Ambient

SOT-23 (TO-236): 3-LEAD



| Dim | MILLIMETERS | | INCHES | |
|---|-------------|------|------------|-------|
| | Min | Max | Min | Max |
| A | 0.89 | 1.12 | 0.035 | 0.044 |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.085 | 0.18 | 0.003 | 0.007 |
| D | 2.80 | 3.04 | 0.110 | 0.120 |
| E | 2.10 | 2.64 | 0.083 | 0.104 |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 |
| e | 0.95 BSC | | 0.0374 Ref | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | |
| L | 0.40 | 0.60 | 0.016 | 0.024 |
| L ₁ | 0.64 Ref | | 0.025 Ref | |
| S | 0.50 Ref | | 0.020 Ref | |
| q | 3° | 8° | 3° | 8° |
| ECN: S-03946-Rev. K, 09-Jul-01 DWG: 5479 | | | | |

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

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